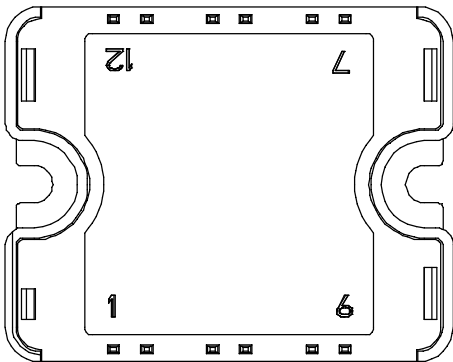
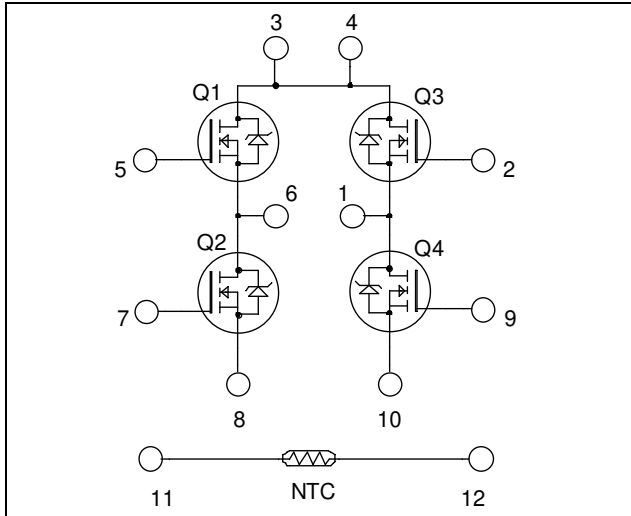


## Full - Bridge MOSFET Power Module

$V_{DSS} = 1000V$   
 $R_{DSon} = 800m\Omega$  typ @  $T_j = 25^\circ C$   
 $I_D = 11A$  @  $T_c = 25^\circ C$



Pins 3/4 must be shorted together

### Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

### Features


- Power MOS 8™ Fast FREDFETs
  - Low  $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Fast intrinsic reverse diode
  - Avalanche energy rated
  - Very rugged
- Very low stray inductance
  - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration

### Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Each leg can be easily paralleled to achieve a phase leg of twice the current capability
- RoHS Compliant

### Absolute maximum ratings

| Symbol     | Parameter   | Max ratings        | Unit       |
|------------|---|--------------------|------------|
| $V_{DSS}$  | Drain - Source Breakdown Voltage                  | 1000               | V          |
| $I_D$      | Continuous Drain Current                          | $T_c = 25^\circ C$ | 11         |
|            |   | $T_c = 80^\circ C$ | 8          |
| $I_{DM}$   | Pulsed Drain current                              | 68                 | A          |
| $V_{GS}$   | Gate - Source Voltage                             | $\pm 30$           | V          |
| $R_{DSon}$ | Drain - Source ON Resistance                      | 960                | m $\Omega$ |
| $P_D$      | Maximum Power Dissipation                         | $T_c = 25^\circ C$ | 208        |
| $I_{AR}$   | Avalanche current (repetitive and non repetitive) | 9                  | A          |


**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

| Symbol       | Characteristic                  | Test Conditions                                 | Min                       | Typ | Max       | Unit             |               |
|--------------|---------------------------------|---|---------------------------|-----|-----------|------------------|---------------|
| $I_{DSS}$    | Zero Gate Voltage Drain Current | $V_{DS} = 1000\text{V}$<br>$V_{GS} = 0\text{V}$ | $T_j = 25^\circ\text{C}$  |     |           | 250              | $\mu\text{A}$ |
|              |                                 |   | $T_j = 125^\circ\text{C}$ |     |           | 1000             |               |
| $R_{DS(on)}$ | Drain – Source on Resistance    | $V_{GS} = 10\text{V}, I_D = 9\text{A}$          |                           | 800 | 960       | $\text{m}\Omega$ |               |
| $V_{GS(th)}$ | Gate Threshold Voltage          | $V_{GS} = V_{DS}, I_D = 1\text{mA}$             | 3                         | 4   | 5         | V                |               |
| $I_{GSS}$    | Gate – Source Leakage Current   | $V_{GS} = \pm 30\text{V}$                       |                           |     | $\pm 100$ | nA               |               |

**Dynamic Characteristics**

| Symbol       | Characteristic               | Test Conditions  | Min | Typ  | Max | Unit        |
|--------------|------------------------------|--|-----|------|-----|-------------|
| $C_{iss}$    | Input Capacitance            | $V_{GS} = 0\text{V}$<br>$V_{DS} = 25\text{V}$<br>$f = 1\text{MHz}$   |     | 3876 |     | $\text{pF}$ |
| $C_{oss}$    | Output Capacitance           |  |     | 405  |     |             |
| $C_{rss}$    | Reverse Transfer Capacitance |  |     | 52   |     |             |
| $Q_g$        | Total gate Charge            | $V_{GS} = 10\text{V}$<br>$V_{Bus} = 500\text{V}$<br>$I_D = 9\text{A}$  |     | 150  |     | nC          |
| $Q_{gs}$     | Gate – Source Charge         |  |     | 26   |     |             |
| $Q_{gd}$     | Gate – Drain Charge          |  |     | 70   |     |             |
| $T_{d(on)}$  | Turn-on Delay Time           | <b>Resistive switching @ <math>25^\circ\text{C}</math></b><br>$V_{GS} = 15\text{V}$<br>$V_{Bus} = 667\text{V}$<br>$I_D = 9\text{A}$<br>$R_G = 4.7\Omega$ |     | 29   |     | ns          |
| $T_r$        | Rise Time                    |  |     | 31   |     |             |
| $T_{d(off)}$ | Turn-off Delay Time          |  |     | 105  |     |             |
| $T_f$        | Fall Time                    |  |     | 28   |     |             |

**Source - Drain diode ratings and characteristics**

| Symbol   | Characteristic                            | Test Conditions  | Min                       | Typ | Max  | Unit          |    |
|----------|---|--|---------------------------|-----|------|---------------|----|
| $I_S$    | Continuous Source current<br>(Body diode) |  | $T_c = 25^\circ\text{C}$  |     |      | 11            | A  |
|          |   |  | $T_c = 80^\circ\text{C}$  |     |      | 8             |    |
| $V_{SD}$ | Diode Forward Voltage                     | $V_{GS} = 0\text{V}, I_S = -9\text{A}$   |                           |     | 1    | V             |    |
| dv/dt    | Peak Diode Recovery ①                     |  |                           |     | 25   | V/ns          |    |
| $t_{rr}$ | Reverse Recovery Time                     | $I_S = -9\text{A}$<br>$V_R = 100\text{V}$<br>$di_S/dt = 100\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$  |     |      | 245           | ns |
|          |   |  | $T_j = 125^\circ\text{C}$ |     |      | 465           |    |
| $Q_{rr}$ | Reverse Recovery Charge                   |  | $T_j = 25^\circ\text{C}$  |     | 1.02 | $\mu\text{C}$ |    |
|          |   |  | $T_j = 125^\circ\text{C}$ |     | 2.57 |               |    |

① dv/dt numbers reflect the limitations of the circuit rather than the device itself.

 $I_S \leq -9\text{A}$     $di/dt \leq 1000\text{A}/\mu\text{s}$     $V_{DD} \leq 400\text{V}$     $T_j \leq 125^\circ\text{C}$

## Thermal and package characteristics

| Symbol            | Characteristic  | Min         | Typ | Max | Unit |     |
|-------------------|---|-------------|-----|-----|------|-----|
| R <sub>thJC</sub> | Junction to Case Thermal Resistance   |             |     | 0.6 | °C/W |     |
| V <sub>ISOL</sub> | RMS Isolation Voltage, any terminal to case t =1 min, I <sub>isol</sub> <1mA, 50/60Hz | 2500        |     |     | V    |     |
| T <sub>J</sub>    | Operating junction temperature range  | -40         |     | 150 | °C   |     |
| T <sub>STG</sub>  | Storage Temperature Range   | -40         |     | 125 |      |     |
| T <sub>C</sub>    | Operating Case Temperature  | -40         |     | 100 |      |     |
| Torque            | Mounting torque   | To heatsink | M4  | 2.5 | 4.7  | N.m |
| Wt                | Package Weight  |             |     | 80  |      | g   |

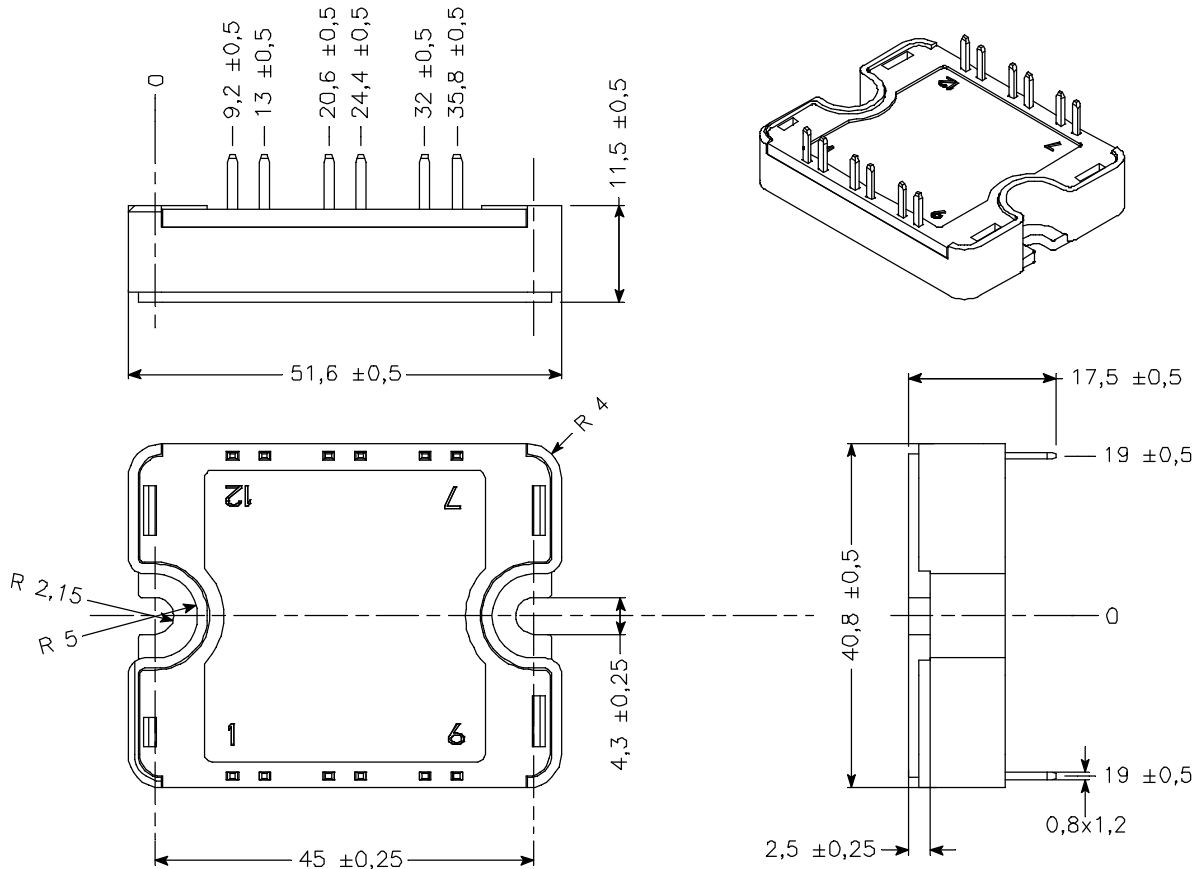
## Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

| Symbol             | Characteristic             | Min | Typ  | Max | Unit |
|--------------------|----------------------------|-----|------|-----|------|
| R <sub>25</sub>    | Resistance @ 25°C          |     | 50   |     | kΩ   |
| B <sub>25/85</sub> | T <sub>25</sub> = 298.15 K |     | 3952 |     | K    |

$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$

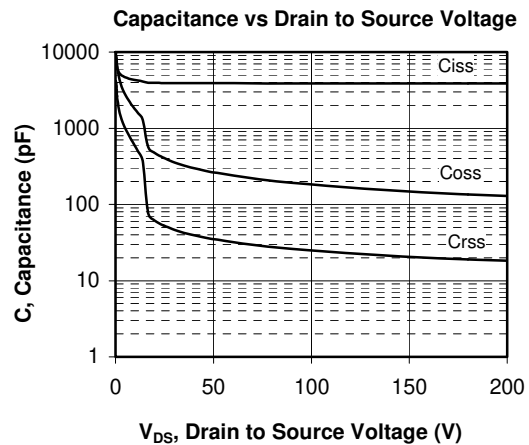
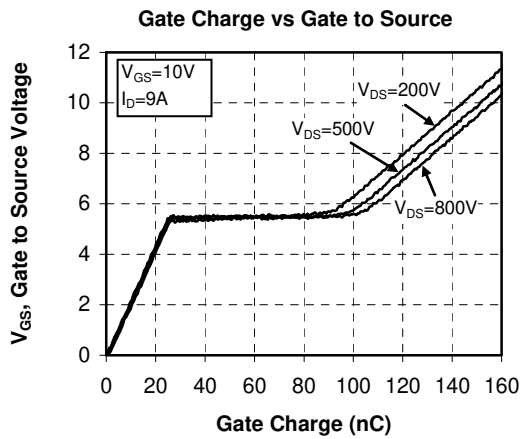
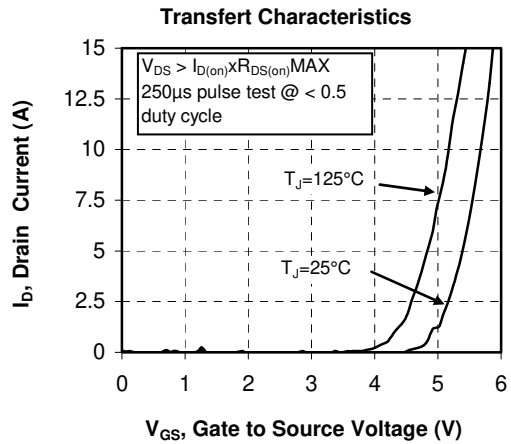
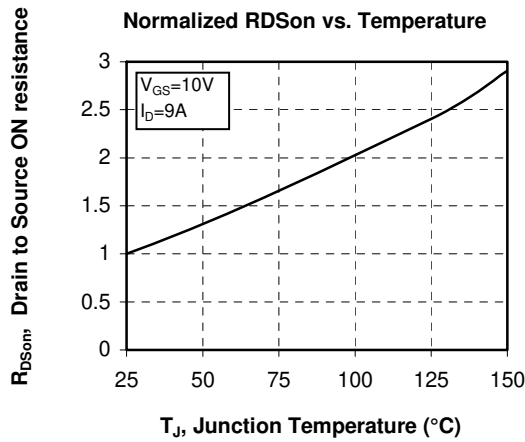
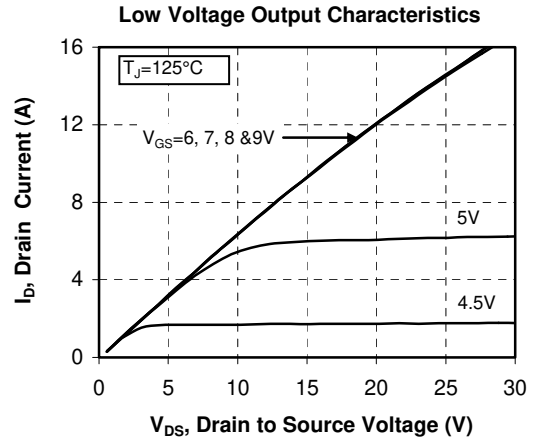
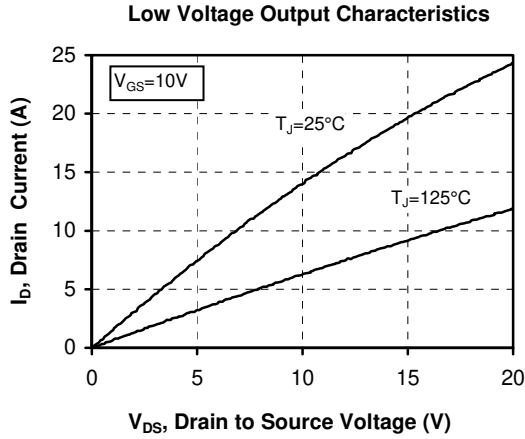
T: Thermistor temperature  
 R<sub>T</sub>: Thermistor value at T

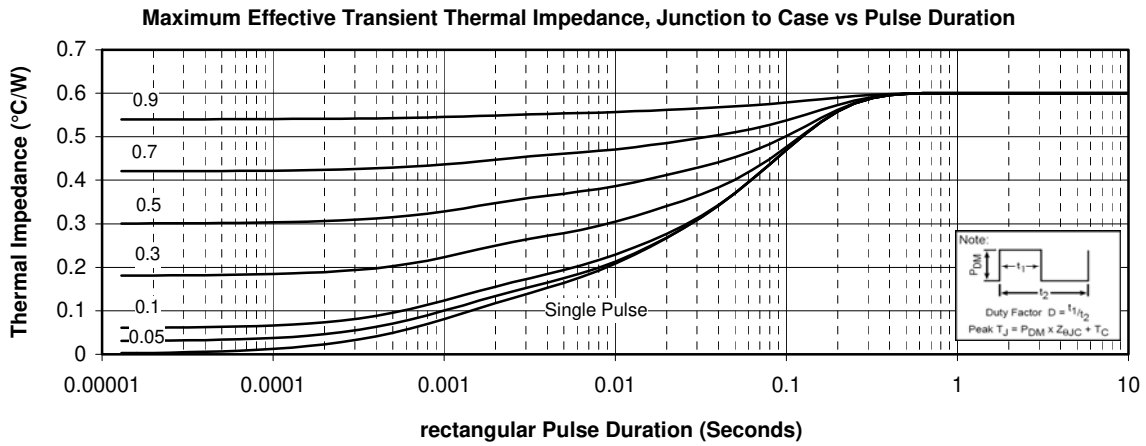
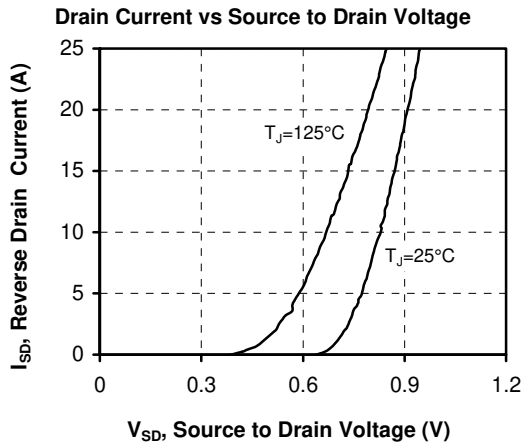
## SP1 Package outline (dimensions in mm)



See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

## Typical Performance Curve





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